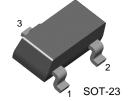


FJV4110R

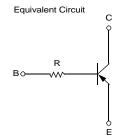
Switching Application (Bias Resistor Built In)

- Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor (R=10K Ω)
- Complement to FJV3110R



1. Base 2. Emitter 3. Collector





PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings T_a =25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	-40	V
V_{CEO}	Collector-Emitter Voltage	-40	V
V _{EBO}	Emitter-Base Voltage	-5	V
I _C	Collector Current	-100	mA
P _C	Collector Power Dissipation	200	mW
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55 ~ 150	°C

$\textbf{Electrical Characteristics} \ \, \textbf{T}_{a} \text{=-} 25 ^{\circ} \textbf{C} \ \, \text{unless otherwise noted}$

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	$I_C = -100 \mu A, I_E = 0$	-40			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	I_E = -1mA, I_B =0	-40			V
I _{CBO}	Collector Cut-off Current	$V_{CB} = -30V, I_{E} = 0$			-0.1	μΑ
h _{FE}	DC Current Gain	V_{CE} = -5V, I_{C} = -1mA	100		600	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = -10mA, I _B = -1mA			-0.3	V
C _{ob}	Output Capacitance	V _{CB} = -10V, I _E =0 f=1MHz		5.5		pF
f _T	Current Gain Bandwidth Product	$V_{CE} = -10V, I_{C} = -5mA$		200		MHz
R	Input Resistor		7	10	13	ΚΩ

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Typical Characteristics

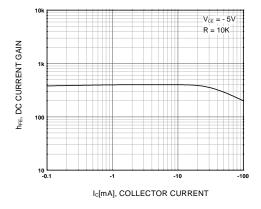


Figure 1. DC current Gain

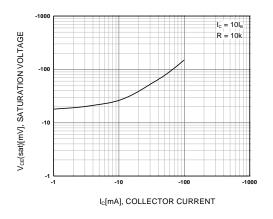


Figure 2. Collector-Emitter Saturation

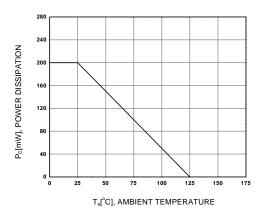
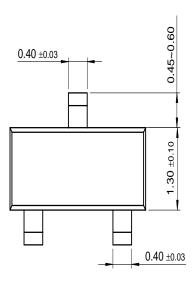


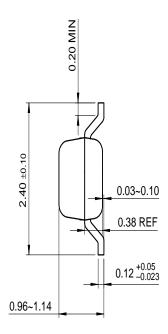
Figure 3. Power Derating

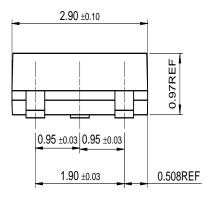
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Package Dimensions

SOT-23







Dimensions in Millimeters

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EcoSPARK™	GTO™	MSX™	QT Optoelectronics™	TinyLogic™
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EnSigna™	I^2C^{TM}	OCX^{TM}	RapidConfigure™	UHC™
Across the board.	. Around the world.™	OCXPro™	RapidConnect™	UltraFET [®]
The Power Franchise™		OPTOLOGIC [®]	SILENT SWITCHER®	VCX™
Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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